

- Excellent accuracy for both altimeter and diving applications until 70m depth
- Operating range: 0 to 7 bar, -20 to +85 °C
- High resolution module, 0.4m air / 1mm water
- Fast conversion down to 1 ms
- Low power, 1  $\mu$ A (standby < 0.15  $\mu$ A)
- 24 bit  $\Delta\Sigma$  calibrated output
- Supply voltage 2.2 to 3.6 V
- I<sup>2</sup>C and SPI interface (Mode 0, 3)
- No external components (Internal oscillator)
- **Excellent long term stability**

### **DESCRIPTION**

The MS5803-07BA is a new digital, fully compensated pressure sensor with SPI and I<sup>2</sup>C bus interface. It is optimized for altimeter and in the same time water depth measurement with high resolution and accuracy. The sensor module includes a high linearity pressure sensor and an ultra low power 24 bit  $\Delta\Sigma$  ADC with internal factory calibrated coefficients. It provides a precise digital 24 Bit pressure and temperature value and different operation modes that allow the user to optimize for conversion speed and current consumption. A high resolution temperature output allows the implementation of a thermometer function without any additional sensor. The MS5803-07BA can be interfaced to virtually any microcontroller. The communication protocol is simple, without the need of programming internal registers in the device. The gel protection and antimagnetic stainless steel cap allows the use in 100m waterproof watches. This new sensor module generation is based on leading MEMS technology and latest benefits from Measurement Specialties proven experience and know-how in high volume manufacturing which have been widely used for over a decade.

### **FEATURES**

### FIELD OF APPLICATION

Dual Mobile altimeter / depth meter systems Adventure or multi-mode watches Diving computers

### **TECHNICAL DATA**

Sensor Performances (V <sub>DD</sub> = 3 V)												
Pressure	Min	Тур	Max	Unit								
Range	0		7	bar								
ADC		24		bit								
Resolution (1), Altimeter mode		mbar										
Accuracy 0°C to +60°C, 400 to 1100 mbar (2)	-4.5		+4.5	mbar								
Accuracy 0°C to + 40°C, 400 to 7000 mbar	-50		+50	mbar								
Response time (2)		5 / 1.1 / 2 4.1 / 8.22		ms								
Long term stability		±1		mbar/yr								
Temperature	Min	Тур	Max	Unit								
Range	-20		+85	°C								
Resolution		<0.01		°C								
Accuracy	-3		+3	°C								

Notes: (1) Oversampling Ratio: 4096

(2) With auto-zero at one pressure point

(3) Oversampling Ratio 4096 / 2048 / 1024 / 512 / 256

## PERFORMANCE SPECIFICATIONS

### **ABSOLUTE MAXIMUM RATINGS**

Parameter	Symbol C		Min.	Тур.	Max	Unit
Supply voltage	$V_{DD}$		-0.3		+3.6	V
Storage temperature	Ts		-40		+85	°C
Overpressure	P <sub>max</sub>	ISO6425			30	bar
Maximum Soldering Temperature	T <sub>max</sub>	40 sec max			250	°C
ESD rating		Human Body Model	-2		2	kV
Latch up		JEDEC standard No 78	-100		+100	mA

### **ELECTRICAL CHARACTERISTICS**

Parameter	Symbol	Conditions	Min.	Тур.	Max	Unit
Operating Supply voltage	$V_{DD}$		2.2	3.0	+3.6	V
Operating Temperature	Т		-20	+25	+85	°C
Output Word				24		bit
Supply current (1 sample per sec.)	I <sub>DD</sub>	Depending on OSR	0.9		12.5	μΑ
Peak supply current		during conversion		1.4		mA
Standby supply current		at 25°c		0.02	0.14	μA
VDD Capacitor		From VDD to GND	100	470		nF

## **ANALOG DIGITAL CONVERTER (ADC)**

Parameter	Symbol	Conditions		Min.	Тур.	Max	Unit
Output Word					24		bit
		OSR	4096	7.40	8.22	9.04	
			2048	3.72	4.13	4.54	
Conversion time	t <sub>c</sub>		1024	1.88	2.08	2.28	ms
			512	0.95	1.06	1.17	
			256	0.48	0.54	0.60	

## PERFORMANCE SPECIFICATIONS (CONTINUED)

## PRESSURE OUTPUT CHARACTERISTICS (V<sub>DD</sub> = 3 V, T = 25°C UNLESS OTHERWISE NOTED)

Parameter	Conditio	ns	Min.	Тур.	Max	Unit
Operating Pressure Range	Prange	Full Accuracy	0		7	bar
Absolute Accuracy, autozero at one pressure point 4001100 mbar	at 060°C	c, 4001100 mbar	-4.5		+4.5	mbar
Absolute Accuracy, autozero at one pressure point 4007000 mbar	at 040	0°C, 07000 mbar	-50		+50	mbar
Maximum error with supply voltage (1)	V <sub>DD</sub> = 2.2	V 3.6 V		±3		mbar
Long-term stability				±1		mbar/yr
Resolution RMS	OSR	4096 2048 1024 512 256		0.034 0.048 0.067 0.097 0.176		mbar

<sup>(1)</sup> With autozero at 3V point

## TEMPERATURE OUTPUT CHARACTERISTICS ( $V_{DD} = 3 \text{ V}, T = 25^{\circ}\text{C}$ UNLESS OTHERWISE NOTED)

Parameter	Conditions		Min.	Тур.	Max	Unit
Absolute Accuracy 4001100mbar	040°C		-1		+1	°C
Absolute Accuracy 4001100mbar	-2085°C		-2		+2	°C
Absolute Accuracy 400 7000mbar	-2085°C		-3		+3	°C
Maximum error with supply voltage (1)	V <sub>DD</sub> = 2.2 V 3.6 V			±0.2		°C
	OSR	4096		0.002		
		2048		0.003		
Resolution RMS		1024		0.005		°C
		512		0.008		
		256		0.012		

<sup>(1)</sup> With autozero at 3V point

## PERFORMANCE SPECIFICATIONS (CONTINUED)

## DIGITAL INPUTS (PS, CSB, DIN, SCLK, SDA, SCL)

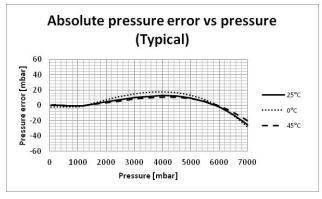
Parameter	Symbol	Conditions	Min.	Тур.	Max	Unit
Serial data clock	SCLK	SPI protocol			20	MHz
Serial data clock	SCL	I2C protocol			400	kHz
Input high voltage	V <sub>IH</sub>	Pins CSB	80% V <sub>DD</sub>		100% V <sub>DD</sub>	V
Input low voltage	V <sub>IL</sub>		0% V <sub>DD</sub>		20% V <sub>DD</sub>	V
Input leakage current	I <sub>leak25°C</sub>	at 25°c			0.15	μA

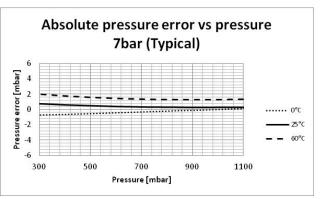
## **DIGITAL OUTPUTS (DOUT, SDA, SCL)**

Parameter	Symbol	Conditions	Min.	Тур.	Max	Unit
Output high voltage	V <sub>OH</sub>	I <sub>source</sub> = 0.6 mA	80% V <sub>DD</sub>		100% V <sub>DD</sub>	V
Output low voltage	$V_{OL}$	$I_{sink} = 0.6 \text{ mA}$	0% V <sub>DD</sub>		$20\% V_{DD}$	V
Load capacitance	C <sub>LOAD</sub>			16		pF

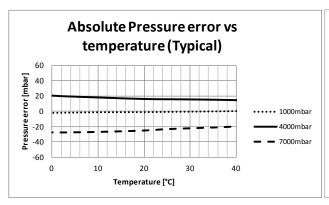
### PERFORMANCE CHARACTERISTICS

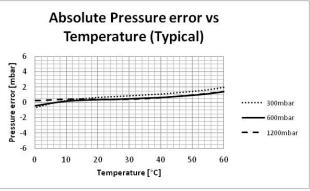
### PRESSURE ERROR VS PRESSURE



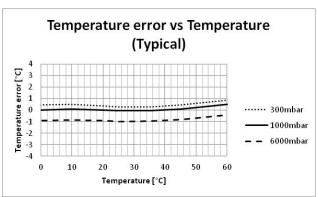


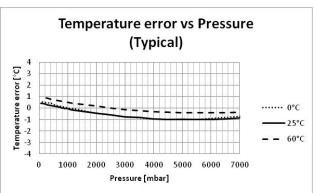
### PRESSURE ERROR VS TEMPERATURE



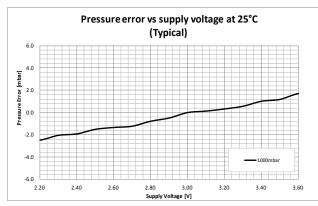


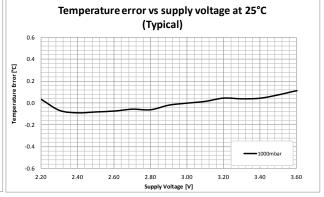
### TEMPERATURE ERROR VS TEMPERATURE AND PRESSURE





## PRESSURE AND TEMPERATURE ERROR VS POWER SUPPLY





### **FUNCTIONAL DESCRIPTION**

#### **GENERAL**

The MS5803-07BA consists of a piezo-resistive sensor and a sensor interface IC. The main function of the MS5803-07BA is to convert the uncompensated analogue output voltage from the piezo-resistive pressure sensor to a 24-bit digital value, as well as providing a 24-bit digital value for the temperature of the sensor.

#### **FACTORY CALIBRATION**

Every module is individually factory calibrated at two temperatures and two pressures. As a result, 6 coefficients necessary to compensate for process variations and temperature variations are calculated and stored in the 128-bit PROM of each module. These bits (partitioned into 7 coefficients W1 to W7) must be read by the microcontroller software and used in the program converting D1 and D2 into compensated pressure and temperature values.

The coefficient W0 is for factory configuration and W7 contains CRC and high pressure range compensation parameters.

### **SERIAL INTERFACE**

The MS5803-07BA has built in two types of serial interfaces: SPI and I<sup>2</sup>C. Pulling the Protocol Select pin PS to low selects the SPI protocol, pulling PS to high activates the I<sup>2</sup>C bus protocol.

Pin PS	Mode	Pins used						
High	I <sup>2</sup> C	SDA, SCL, CSB						
Low	SPI	SDI, SDO, SCLK, CSB						

### **SPI MODE**

The external microcontroller clocks in the data through the input SCLK (Serial CLocK) and SDI (Serial Data In). In the SPI mode module can accept both mode 0 and mode 3 for the clock polarity and phase. The sensor responds on the output SDO (Serial Data Out). The pin CSB (Chip Select) is used to enable/disable the interface, so that other devices can talk on the same SPI bus. The CSB pin can be pulled high after the command is sent or after the end of the command execution (for example end of conversion). The best noise performance from the module is obtained when the SPI bus is quiet and without communication to other devices during the ADC conversion in progress.

### I<sup>2</sup>C MODE

The external microcontroller clocks in the data through the input SCL (Serial CLock) and SDA (Serial DAta). The sensor responds on the same pin SDA which is bidirectional for the I<sup>2</sup>C bus interface. So this interface type uses only 2 signal lines and does not require a chip select, which can be favorable to reduce board space. In I<sup>2</sup>C-Mode the complement of the pin CSB (Chip Select) represents the LSB of the I<sup>2</sup>C address. It is possible to use two sensors with two different addresses on the I<sup>2</sup>C bus. The pin CSB shall be connected to VDD or GND (do not leave unconnected!).

Pin CSB	Address (7 bits)
High	0x76 (1110110 b)
Low	0x77 (1110111 b)

### **COMMANDS**

The MS5803-07BA has only five basic commands:

- 1. Reset
- 2. Read PROM (128 bit of calibration words)
- 3. D1 conversion
- 4. D2 conversion
- 5. Read ADC result (24 bit pressure / temperature)

Size of each command is 1 byte (8 bits) as described in the table below. After ADC read commands the device will return 24 bit result and after the PROM read 16bit result. The address of the PROM is embedded inside of the PROM read command using the Ad2, Ad1 and Ad0 bits.

	Com	mand l	byte						hex value	
Bit number	0	1	2	3	4	5	6	7		
Bit name	PR M	COV	-	Тур	Ad2/ Os2	Ad1/ Os1	Ad0/ Os0	Stop		
Command										
Reset	0	0	0	1	1	1	1	0	0x1E	
Convert D1 (OSR=256)	0	1	0	0	0	0	0	0	0x40	
Convert D1 (OSR=512)	0	1	0	0	0	0	1	0	0x42	
Convert D1 (OSR=1024)	0	1	0	0	0	1	0	0	0x44	
Convert D1 (OSR=2048)	0	1	0	0	0	1	1	0	0x46	
Convert D1 (OSR=4096)	0	1	0	0	1	0	0	0	0x48	
Convert D2 (OSR=256)	0	1	0	1	0	0	0	0	0x50	
Convert D2 (OSR=512)	0	1	0	1	0	0	1	0	0x52	
Convert D2 (OSR=1024)	0	1	0	1	0	1	0	0	0x54	
Convert D2 (OSR=2048)	0	1	0	1	0	1	1	0	0x56	
Convert D2 (OSR=4096)	0	1	0	1	1	0	0	0	0x58	
ADC Read	0	0	0	0	0	0	0	0	0x00	
PROM Read	1	0	1	0	Ad2	Ad1	Ad0	0	0xA0 to 0xAE	

Figure 1: Command structure

#### PRESSURE AND TEMPERATURE CALCULATION Start Maximum values for calculation results: $P_{MIN} = 0mbar$ $P_{MAX} = 7000mbar$ $T_{MIN} = -20$ °C $T_{MAX} = 85$ °C $T_{REF} = 20$ °C Read calibration data (factory calibrated) from PROM Size [1] Value Example / Recommended Variable Description | Equation variable type Typical . [bit] min max 46128 C1 Pressure sensitivity | SENS<sub>T1</sub> unsigned int 16 16 65535 Pressure offset | OFF<sub>T</sub> unsigned int 16 65535 40903 СЗ Temperature coefficient of pressure sensitivity | TCS unsigned int 16 16 0 65535 27765 C4 Temperature coefficient of pressure offset | TCO unsigned int 16 16 0 65535 26239 C5 Reference temperature | T<sub>REF</sub> unsigned int 16 16 0 65535 31876 C6 16 65535 28261 Temperature coefficient of the temperature | TEMPSENS unsigned int 16 0 Read digital pressure and temperature data Digital pressure value unsigned int 32 16777215 10332180 8592698 Digital temperature value unsigned int 32 0 16777215 Calculate temperature Difference between actual and reference temperature [2] dΤ signed int 32 25 -16776960 16777215 432442 $dT = D2 - T_{REF} = D2 - C5 * 2^8$ 3456 Actual temperature (-40...85°C with 0.01°C resolution) signed int 32 41 -4000 8500 TEMP = 20°C + dT \* TEMPSENS = 2000 + dT \* C6 / 2<sup>23</sup> 34.56 °C Calculate temperature compensated pressure Offset at actual temperature [3] OFF signed int 64 -34358689800 51538821120 11077064958 $OFF = OFF_{T1} + TCO^{*}dT = C2^{*}2^{18} + (C4^{*}dT)/2^{5}$ Sensitivity at actual temperature [4] SENS signed int 64 41 -8589672450 17179607040 6233694718 SENS = SENS<sub>T1</sub> + TCS\* $dT = C1 * 2^{17} + (C3 * dT)/2^{6}$ Temperature compensated pressure (0...7000mbar with 599209 0.04mbar resolution) $P = D1 * SENS - OFF = (D1 * SENS / 2^{21} - OFF) / 2^{15}$ signed int 32 0 600000 = 5992.09 mbar Display pressure and temperature value Notes [1] Maximal size of intermediate result during evaluation of variable min and max have to be defined min and max have to be defined

Figure 2: Flow chart for pressure and temperature reading and software compensation.

min and max have to be defined

### SECOND ORDER TEMPERATURE COMPENSATION

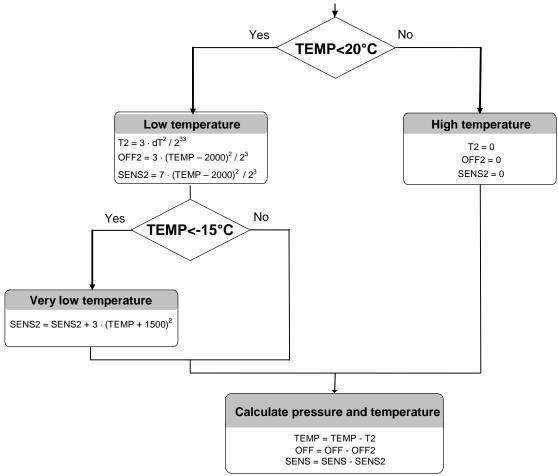


Figure 3: Flow chart for pressure and temperature to the optimum accuracy.

### HIGH PRESSURE RANGE COMPENSATION

The last 16bits word of the PROM (Word7) is defined as follow: C8 (6 Bit) CRC C7 (6bit) DB4 DB1 DB2 Word 7 DB5 DB4 DB3 DB2 DB1 DB5 DB3 DB2 DB1 DB0

Figure 4: Word 7, bit description.

The first 4 bits (bit 0 to 3) of word 7 correspond to the checksum, the 6 following bits (bit 4 to 9) correspond to the C7 coefficient and the 6 last bits (bit 10 to 15) correspond to C8 coefficient.

When defining P and T as the pressure and temperature issued from the pressure and temperature calculation (p8), the compensated high pressure P3 is defined as follow:

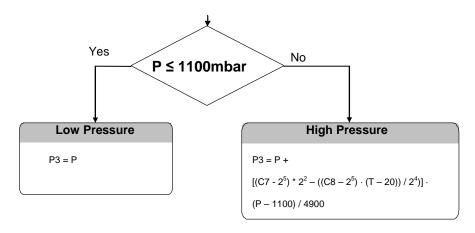


Figure 5: Flow chart for High pressure P3 calculation

### **SPI INTERFACE**

### **RESET SEQUENCE**

The Reset sequence shall be sent once after power-on to make sure that the calibration PROM gets loaded into the internal register. It can be also used to reset the device ROM from an unknown condition

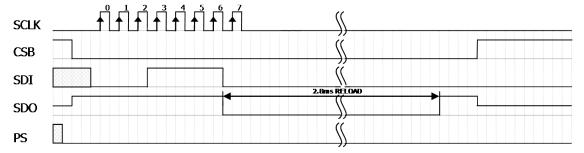


Figure 6: Reset command sequence SPI mode 0

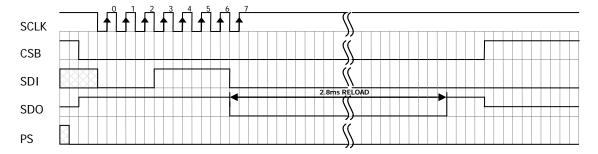


Figure 7: Reset command sequence SPI mode 3

#### **CONVERSION SEQUENCE**

The conversion command is used to initiate uncompensated pressure (D1) or uncompensated temperature (D2) conversion. The chip select can be disabled during this time to communicate with other devices. After the conversion, using ADC read command the result is clocked out with the MSB first. If the conversion is not executed before the ADC read command, or the ADC read command is repeated, it will give 0 as the output result. If the ADC read command is sent during conversion the result will be 0, the conversion will not stop and the final result will be wrong. Conversion sequence sent during the already started conversion process will yield incorrect result as well.

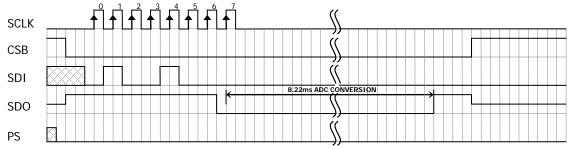


Figure 8: Conversion out sequence, Typ=d1, OSR = 4096

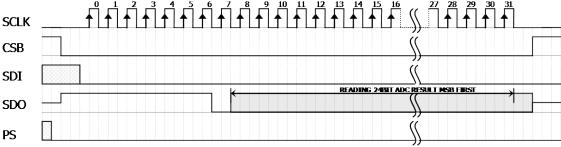


Figure 9: ADC Read sequence

### **PROM READ SEQUENCE**

The read command for PROM shall be executed once after reset by the user to read the content of the calibration PROM and to calculate the calibration coefficients. There are in total 8 addresses resulting in a total memory of 128 bit. Address 0 contains factory data and the setup, addresses 1-6 calibration coefficients and address 7 contains the serial code and CRC. The command sequence is 8 bits long with a 16 bit result which is clocked with the MSB first.

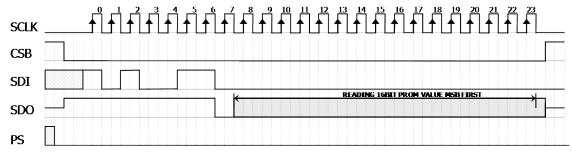


Figure 10: PROM Read sequence, address = 011 (Coefficient 3).

### I<sup>2</sup>C INTERFACE

### **COMMANDS**

Each I<sup>2</sup>C communication message starts with the start condition and it is ended with the stop condition. The MS5803-07BA address is 111011Cx, where C is the complementary value of the pin CSB. Since the IC does not have a microcontroller inside, the commands for I<sup>2</sup>C and SPI are guite similar.

### **RESET SEQUENCE**

The reset can be sent at any time. In the event that there is not a successful power on reset this may be caused by the SDA being blocked by the module in the acknowledge state. The only way to get the MS5803-07BA to function is to send several SCLKs followed by a reset sequence or to repeat power on reset.

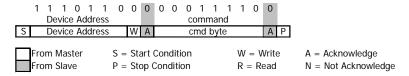


Figure 11: I<sup>2</sup>C Reset Command

### **CONVERSION SEQUENCE**

A conversion can be started by sending the command to MS5803-07BA. When command is sent to the system it stays busy until conversion is done. When conversion is finished the data can be accessed by sending a Read command, when an acknowledge appears from the MS5803-07BA, 24 SCLK cycles may be sent to receive all result bits. Every 8 bit the system waits for an acknowledge signal.

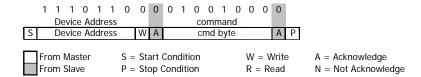


Figure 12: I<sup>2</sup>C Command to initiate a pressure conversion (OSR=4096, typ=D1)

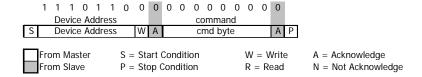


Figure 13: I<sup>2</sup>C ADC read sequence

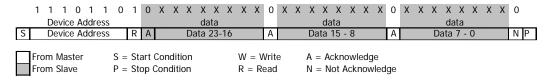


Figure 14: I<sup>2</sup>C answer from MS5803-07BA

### PROM READ SEQUENCE

The PROM Read command consists of two parts. First command sets up the system into PROM read mode. The second part gets the data from the system.

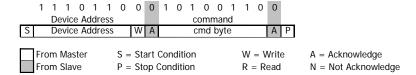


Figure 15: I<sup>2</sup>C Command to read memory address= 011 (Coefficient 3)

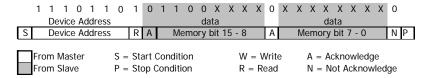


Figure 16: I<sup>2</sup>C answer from MS5803-07BA

### CYCLIC REDUNDANCY CHECK (CRC)

MS5803-07BA contains a PROM memory with 128-Bit. A 4-bit CRC has been implemented to check the data validity in memory.

A d d	D B 1 5	D B 1 4	D B 1 3	D B 1 2	D B 1	D B 1 0	D B 9	D B 8	D B 7	D B 6	D B 5	D B 4	D B 3	D B 2	D B 1	D B 0
0		16 bit reserved for manufacturer														
1		C1 (16 bit unsigned)														
2		C2 (16 bit unsigned)														
3					С	3 (	16	bit	un	sig	nec	(k				
4					С	4 (	16	bit	un	sig	nec	(k				
5					С	5 (	16	bit	un	sig	nec	(k				
6	ĺ	C6 (16 bit unsigned)														
7		C	8 (6	Sbit	s)			C	7 (6	3bit	s)			CF	КC	

Figure 17: Memory PROM mapping

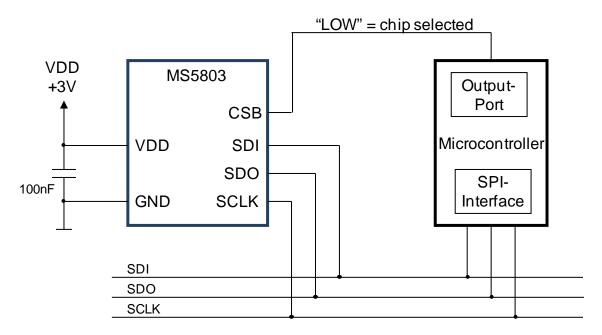
### C Code example for CRC-4 calculation:

```
unsigned char crc4(unsigned int n_prom[])
int cnt;
                                                                      // simple counter
unsigned int n_rem=0;
                                                                      // crc reminder
unsigned char n_bit;
          n_prom[7]=((n_prom[7]) & 0xFFF0);
                                                                      // CRC byte is replaced by 0
          for (cnt = 0; cnt < 16; cnt++)
                                                                      // operation is performed on bytes
                                                                      // choose LSB or MSB
                    if (cnt%2==1)
                                       n_rem ^= (unsigned short) ((n_prom[cnt>>1]) & 0x00FF);
                                       n_rem ^= (unsigned short) (n_prom[cnt>>1]>>8);
                    for (n_bit = 8; n_bit > 0; n_bit--)
                              if (n_rem & (0x8000))
                                                            n_{rem} = (n_{rem} << 1) ^0x3000;
                                                            n_rem = (n_rem << 1);
                              else
          n_rem= ((n_rem >> 12) & 0x000F);
                                                                      // final 4-bit reminder is CRC code
          return (n_rem ^ 0x00);
}
```

### **APPLICATION CIRCUIT**

The MS5803-07BA is a circuit that can be used in conjunction with a microcontroller in mobile altimeter applications. It is designed for low-voltage systems with a supply voltage of 3 V.

## **SPI protocol communication**



## I<sup>2</sup>C protocol communication

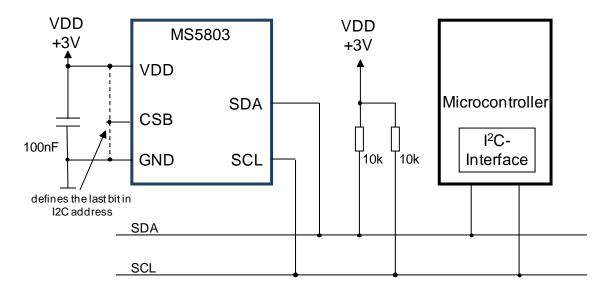


Figure 18: Typical application circuit with SPI / I<sup>2</sup>C protocol communication

## PACKAGE OUTLINE AND PIN CONFIGURATION

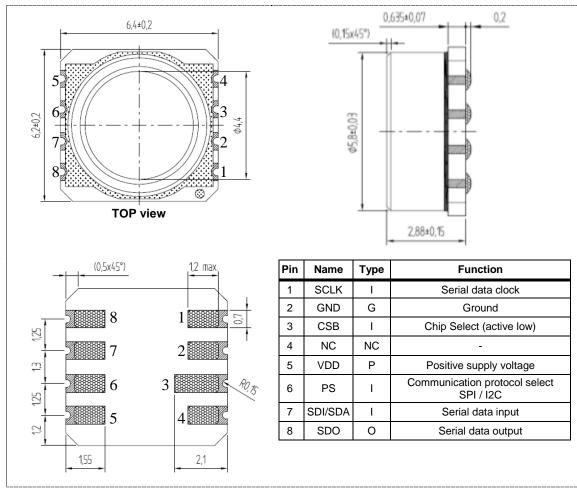


Figure 19: MS5803-07BA package outlines, pin configuration and description

Notes:

- (1) Dimensions in mm
- (2) General tolerance ±0.1
- (3) Cap centering  $\pm$  0.15 from center of the ceramic

### **RECOMMENDED PAD LAYOUT**

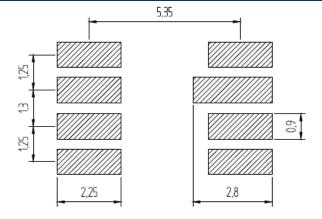
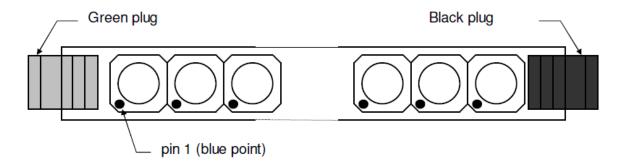


Figure 20: MS5803-07BA recommended pad layout

## SHIPPING PACKAGE



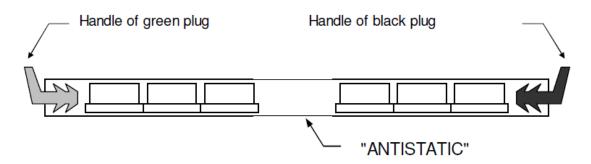


Figure 21: MS5803-07BA tube shipping package

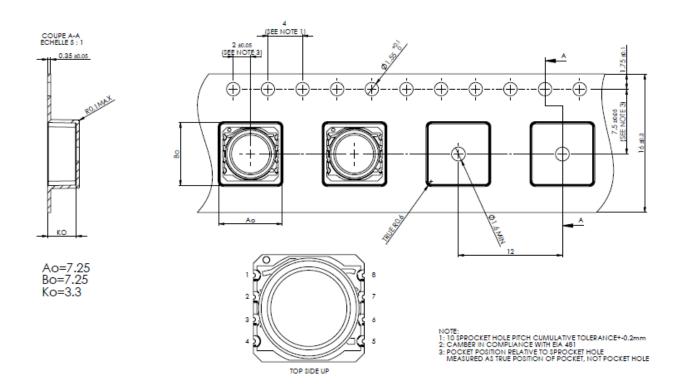


Figure 22: MS5803-07BA Tape & reel shipping package

### MOUNTING AND ASSEMBLY CONSIDERATIONS

### **SOLDERING**

Please refer to the application note AN808 available on our website for all soldering issues.

### **MOUNTING**

The MS5803-07BA can be placed with automatic Pick & Place equipment using vacuum nozzles. It will not be damaged by the vacuum. Due to the low stress assembly the sensor does not show pressure hysteresis effects. It is important to solder all contact pads.

### **CONNECTION TO PCB**

The package outline of the module allows the use of a flexible PCB for interconnection. This can be important for applications in watches and other special devices.

### **SEALING WITH O-RINGS**

In products like outdoor watches the electronics must be protected against direct water or humidity. For those products the MS5803-07BA provides the possibility to seal with an O-ring. The protective cap of the MS5803-07BA is made of special anticorrosive stainless steel with a polished surface. In addition to this the MS5803-07BA is filled with silicone gel covering the sensor and the bonding wires. The O-ring (or O-rings) shall be placed at the outer diameter of the metal cap. This method avoids mechanical stress because the sensor can move in vertical direction.

#### **CLEANING**

The MS5803-07BA has been manufactured under cleanroom conditions. It is therefore recommended to assemble the sensor under class 10'000 or better conditions. Should this not be possible, it is recommended to protect the sensor opening during assembly from entering particles and dust. To avoid cleaning of the PCB, solder paste of type "no-clean" shall be used. Cleaning might damage the sensor!

### **ESD PRECAUTIONS**

The electrical contact pads are protected against ESD up to 2 kV HBM (human body model). It is therefore essential to ground machines and personnel properly during assembly and handling of the device. The MS5803-07BA is shipped in antistatic transport boxes. Any test adapters or production transport boxes used during the assembly of the sensor shall be of an equivalent antistatic material.

### **DECOUPLING CAPACITOR**

Particular care must be taken when connecting the device to the power supply. A minimum 100 nF ceramic capacitor must be placed as close as possible to the MS5803-07BA VDD pin. This capacitor will stabilize the power supply during data conversion and thus, provide the highest possible accuracy.

### ORDERING INFORMATION

Part Number / Article Number	Product	Delivery Form
MS580307BA06-00	MS5803-07BA Double Range Pressure Sensor	Tube
MS580307BA06-50	MS5803-07BA Double Range Pressure Sensor T&R	Tape and Reel

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